# Single 2-input multiplexer Rev. 6 — 31 December 2012

**Product data sheet** 

#### 1. **General description**

The 74LVC1G157 is a single 2-input multiplexer which select data from two data inputs (I0 and I1) under control of a common data select input (S). The state of the common data select input determines the particular register from which the data comes. The output (Y) presents the selected data in the true (non-inverted) form.

Inputs can be driven from either 3.3 V or 5 V devices. This feature allows the use of these devices as translators in mixed 3.3 V and 5 V applications.

This device is fully specified for partial power-down applications using I<sub>OFF</sub>. The I<sub>OFF</sub> circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

Schmitt-trigger action at all inputs makes the circuit highly tolerant to slower input rise and fall times.

#### **Features and benefits** 2.

- Wide supply voltage range from 1.65 V to 5.5 V
- High noise immunity
- Complies with JEDEC standard:
  - ◆ JESD8-7 (1.65 V to 1.95 V)
  - ◆ JESD8-5 (2.3 V to 2.7 V)
  - ◆ JESD8B/JESD36 (2.7 V to 3.6 V)
- $\pm$  24 mA output drive (V<sub>CC</sub> = 3.0 V)
- CMOS low power consumption
- Latch-up performance exceeds 250 mA
- Direct interface with TTL levels
- Inputs accept voltages up to 5 V
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



# 3. Ordering information

Table 1. Ordering information

Type number	Package						
	Temperature range	Name	Description	Version			
74LVC1G157GW	–40 °C to +125 °C	SC-88	plastic surface-mounted package; 6 leads	SOT363			
74LVC1G157GV	–40 °C to +125 °C	SC-74	plastic surface-mounted package (TSOP6); 6 leads	SOT457			
74LVC1G157GM	–40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 $\times$ 1.45 $\times$ 0.5 mm	SOT886			
74LVC1G157GF	–40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 $\times$ 1 $\times$ 0.5 mm	SOT891			
74LVC1G157GN	–40 °C to +125 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body $0.9 \times 1.0 \times 0.35$ mm	SOT1115			
74LVC1G157GS	–40 °C to +125 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body 1.0 $\times$ 1.0 $\times$ 0.35 mm	SOT1202			

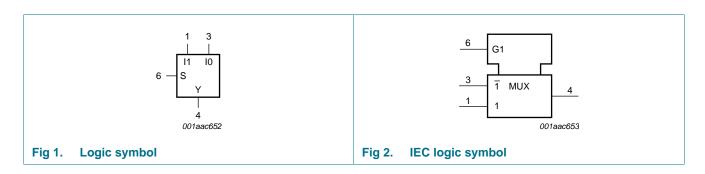
## 4. Marking

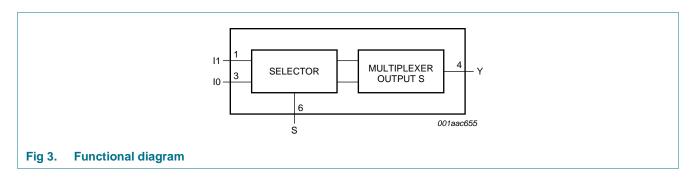
Table 2. Marking

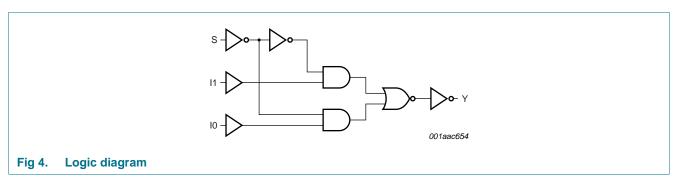
Type number	Marking code <sup>[1]</sup>
74LVC1G157GW	YP
74LVC1G157GV	YP
74LVC1G157GM	YP
74LVC1G157GF	YP
74LVC1G157GN	YP
74LVC1G157GS	YP

<sup>[1]</sup> The pin 1 indicator is located on the lower left corner of the device, below the marking code.

# 5. Functional diagram

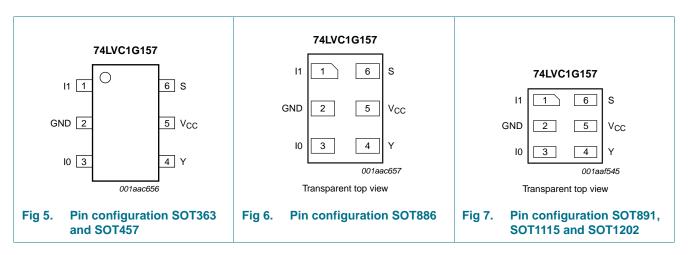






# 6. Pinning information

#### 6.1 Pinning



### 6.2 Pin description

Table 3. Pin description

Symbol	Pin	Description
I1	1	data input from source 1
GND	2	ground (0 V)
10	3	data input from source 0
Υ	4	multiplexer output
V <sub>CC</sub>	5	supply voltage
S	6	common data select input

## 7. Functional description

Table 4. Function table[1]

Inputs			Output
S	l1	10	Υ
L	X	L	L
L	X	Н	Н
Н	L	X	L
Н	Н	X	Н

<sup>[1]</sup> H = HIGH voltage level;

# 8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage		-0.5	+6.5	V
$I_{IK}$	input clamping current	$V_I < 0 V$	-50	-	mA
$V_{I}$	input voltage		<u>[1]</u> –0.5	+6.5	V
$I_{OK}$	output clamping current	$V_O > V_{CC}$ or $V_O < 0 V$	-	±50	mA
$V_{O}$	output voltage	Active mode	[1][2] -0.5	$V_{CC} + 0.5$	V
		Power-down mode	[1][2] -0.5	+6.5	V
Io	output current	$V_O = 0 V \text{ to } V_{CC}$	-	±50	mA
$I_{CC}$	supply current		-	100	mA
$I_{GND}$	ground current		-100	-	mA
$P_{tot}$	total power dissipation	$T_{amb}$ = -40 °C to +125 °C	[3] _	250	mW
$T_{stg}$	storage temperature		-65	+150	°C

<sup>[1]</sup> The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

74LVC1G157

L = LOW voltage level;

X = don't care.

<sup>[2]</sup> When  $V_{CC} = 0 \text{ V}$  (Power-down mode), the output voltage can be 5.5 V in normal operation.

<sup>[3]</sup> For SC-88 and SC-74 packages: above 87.5 °C the value of  $P_{tot}$  derates linearly with 4.0 mW/K. For XSON6 package: above 118 °C the value of  $P_{tot}$  derates linearly with 7.8 mW/K.

# 9. Recommended operating conditions

Table 6. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{CC}$	supply voltage		1.65	-	5.5	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	Active mode	-	-	$V_{CC}$	V
		V <sub>CC</sub> = 0 V; Power-down mode	-	-	5.5	V
T <sub>amb</sub>	ambient temperature		-40	-	+125	°C
Δt/ΔV	input transition rise and fall rate	$V_{CC}$ = 1.65 V to 2.7 V	-	-	20	ns/V
		V <sub>CC</sub> = 2.7 V to 5.5 V	-	-	10	ns/V

## 10. Static characteristics

Table 7. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40 °	°C to +85	5 °C	-40 °C to	Unit	
		Min	Typ[1]	Max	Min	Max		
$V_{IH}$	HIGH-level	V <sub>CC</sub> = 1.65 V to 1.95 V	0.65V <sub>CC</sub>	-	-	0.65V <sub>CC</sub>	-	V
	input voltage	V <sub>CC</sub> = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
		V <sub>CC</sub> = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V
		V <sub>CC</sub> = 4.5 V to 5.5 V	0.7V <sub>CC</sub>	-	-	$0.7V_{CC}$	-	V
V <sub>IL</sub>	LOW-level	V <sub>CC</sub> = 1.65 V to 1.95 V	-	-	0.35V <sub>CC</sub>	-	0.35V <sub>CC</sub>	V
	input voltage	V <sub>CC</sub> = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
		V <sub>CC</sub> = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V
		V <sub>CC</sub> = 4.5 V to 5.5 V	-	-	$0.3V_{CC}$	-	$0.3V_{CC}$	V
V <sub>OH</sub>	HIGH-level	$V_I = V_{IH}$ or $V_{IL}$						
	output voltage	$I_O = -100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 5.5 \text{ V}$	V <sub>CC</sub> – 0.1	-	-	V <sub>CC</sub> – 0.1	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	1.54	-	0.95	-	V
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.9	2.15	-	1.7	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	2.50	-	1.9	-	V
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.3	2.62	-	2.0	-	V
		$I_{O} = -32 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.8	4.11	-	3.4	-	V
V <sub>OL</sub>	LOW-level	$V_I = V_{IH}$ or $V_{IL}$						
	output voltage	$I_O = 100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 5.5 \text{ V}$	-	-	0.10	-	0.10	V
		$I_{O} = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	0.07	0.45	-	0.70	V
		$I_{O} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	0.12	0.30	-	0.45	V
		$I_{O}$ = 12 mA; $V_{CC}$ = 2.7 V	-	0.17	0.40	-	0.60	V
		$I_{O} = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	0.33	0.55	-	0.80	٧
		$I_{O} = 32 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	0.39	0.55	-	0.80	V
I <sub>I</sub>	input leakage current	$V_I = 5.5 \text{ V or GND};$ $V_{CC} = 0 \text{ V to } 5.5 \text{ V}$	-	±0.1	±5	-	±20	μΑ

 Table 7.
 Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol Parameter		Conditions	-40 °	-40 °C to +85 °C			-40 °C to +125 °C	
			Min	Typ[1]	Max	Min	Max	
I <sub>OFF</sub>	power-off leakage current	$V_{CC} = 0 \text{ V}$ ; $V_I \text{ or } V_O = 5.5 \text{ V}$	-	±0.1	±10	-	±20	μΑ
I <sub>CC</sub>	supply current	$V_I = 5.5 \text{ V or GND}; I_O = 0 \text{ A};$ $V_{CC} = 1.65 \text{ V to } 5.5 \text{ V}$	-	0.1	10	-	40	μΑ
$\Delta I_{CC}$	additional supply current	per pin; $V_{CC} = 2.3 \text{ V to } 5.5 \text{ V};$ $V_{I} = V_{CC} - 0.6 \text{ V}; I_{O} = 0 \text{ A}$	-	5	500	-	5000	μΑ
Cı	input capacitance	$V_{CC}$ = 3.3 V; $V_I$ = GND to $V_{CC}$	-	2.5	-	-	-	pF

<sup>[1]</sup> All typical values are measured at  $T_{amb}$  = 25 °C.

# 11. Dynamic characteristics

 Table 8.
 Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for load circuit see Figure 9.

Symbol	Parameter	Conditions		-40 °C to +85 °C			-40 °C to	+125 °C	Unit
			Ī	Min	Typ[1]	Max	Min	Max	
t <sub>pd</sub>	propagation delay	I0, I1 to Y; see Figure 8	[2]		'				'
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		1.5	4.3	11.0	1.5	13.0	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.0	2.9	6.1	1.0	7.6	ns
		$V_{CC} = 2.7 \text{ V}$		1.0	3.1	5.6	1.0	7.0	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.0	2.7	5.0	1.0	6.3	ns
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		0.5	2.2	4.0	0.5	5.0	ns
		S to Y; see Figure 8	[2]						
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		1.5	4.3	11.0	1.5	13.0	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.0	2.9	6.9	1.0	8.6	ns
		$V_{CC} = 2.7 \text{ V}$		1.0	3.3	5.9	1.0	7.4	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.0	2.9	5.0	1.0	6.3	ns
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		0.5	2.3	4.0	0.5	5.0	ns
$C_{PD}$	power dissipation capacitance	$V_I = GND \text{ to } V_{CC}; V_{CC} = 3.3 \text{ V}$	[3]	-	18	-	-	-	pF

<sup>[1]</sup> Typical values are measured at  $T_{amb} = 25$  °C and  $V_{CC} = 1.8$  V, 2.5 V, 2.7 V, 3.3 V and 5.0 V respectively.

 $P_D = C_{PD} \times V_{CC}{}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}{}^2 \times f_o)$  where:

 $f_i$  = input frequency in MHz;

f<sub>o</sub> = output frequency in MHz;

C<sub>L</sub> = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in Volts;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$  = sum of the outputs.

<sup>[2]</sup>  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .

<sup>[3]</sup>  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

### 12. Waveforms

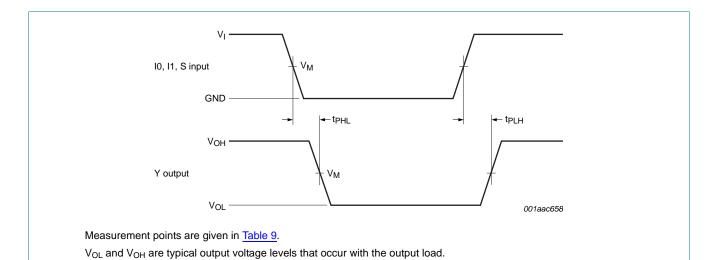


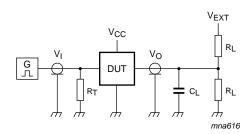
Table 9. Measurement points

Fig 8.

Table of Modern Street			
Supply voltage	Input	Output	
V <sub>CC</sub>	V <sub>M</sub>	V <sub>M</sub>	
1.65 V to 1.95 V	0.5V <sub>CC</sub>	0.5V <sub>CC</sub>	
2.3 V to 2.7 V	0.5V <sub>CC</sub>	0.5V <sub>CC</sub>	
2.7 V	1.5 V	1.5 V	
3.0 V to 3.6 V	1.5 V	1.5 V	
4.5 V to 5.5 V	0.5V <sub>CC</sub>	0.5V <sub>CC</sub>	

Data inputs (I0, I1) and common data select input (S) to output (Y) propagation delays

#### Single 2-input multiplexer



Test data is given in Table 10.

Definitions for test circuit:

 $R_L$  = Load resistance.

 $C_L$  = Load capacitance including jig and probe capacitance.

 $R_T$  = Termination resistance; should be equal to the output impedance  $Z_o$  of the pulse generator.

 $V_{\text{EXT}}$  = External voltage for measuring switching times.

Fig 9. Test circuit for measuring switching times

Table 10. Test data

Supply voltage	Input		Load		V <sub>EXT</sub>
V <sub>CC</sub>	VI	$t_r = t_f$	CL	$R_L$	t <sub>PLH</sub> , t <sub>PHL</sub>
1.65 V to 1.95 V	V <sub>CC</sub>	$\leq$ 2.0 ns	30 pF	1 kΩ	open
2.3 V to 2.7 V	$V_{CC}$	≤ 2.0 ns	30 pF	500 $\Omega$	open
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open
4.5 V to 5.5 V	V <sub>CC</sub>	≤ 2.5 ns	50 pF	500 Ω	open

## 13. Package outline

#### Plastic surface-mounted package; 6 leads

**SOT363** 

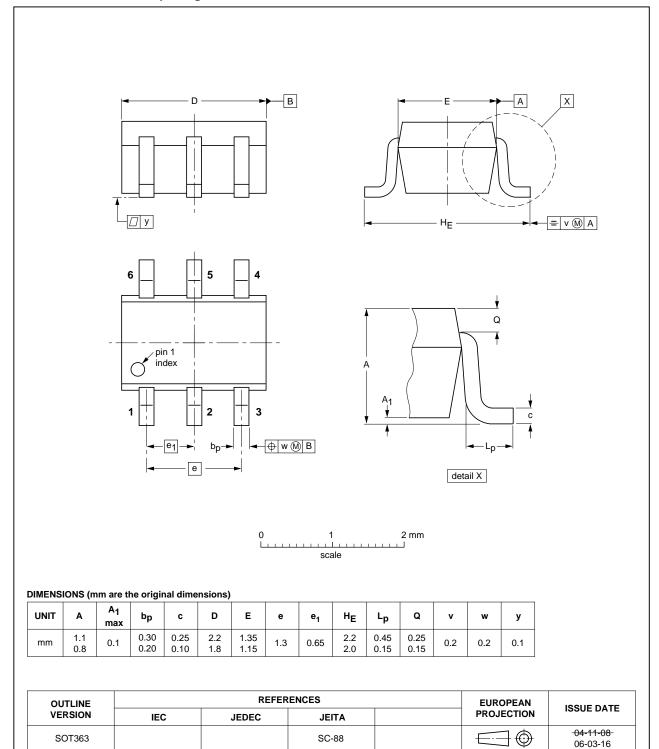


Fig 10. Package outline SOT363 (SC-88)

#### Plastic surface-mounted package (TSOP6); 6 leads

**SOT457** 

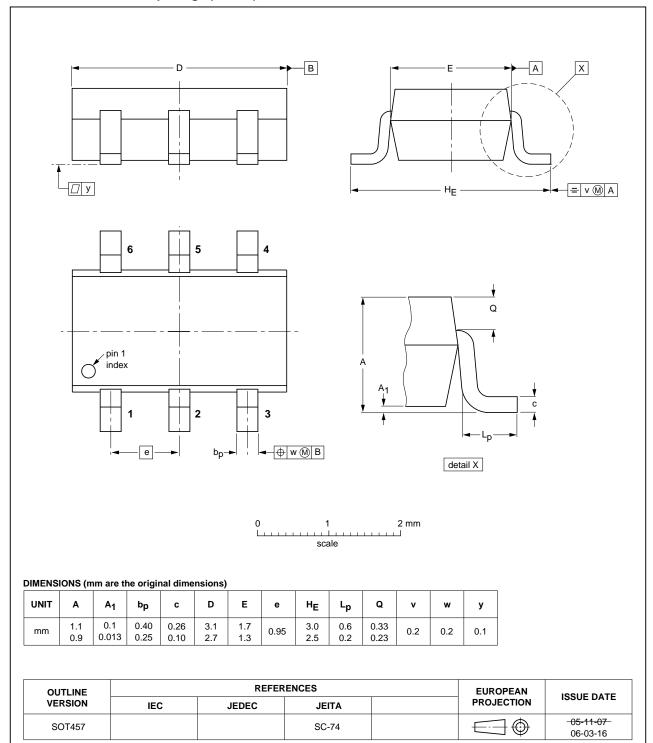


Fig 11. Package outline SOT457 (SC-74)

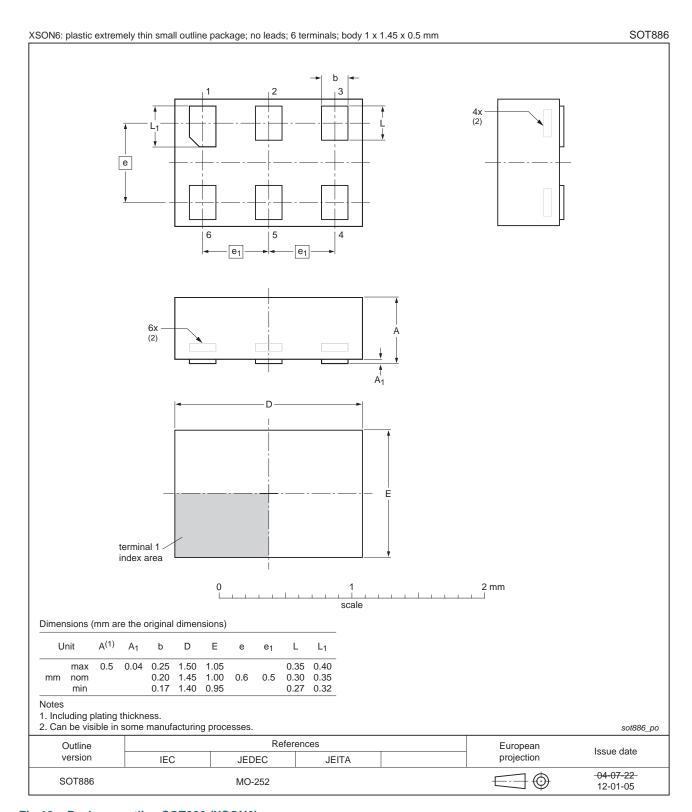


Fig 12. Package outline SOT886 (XSON6)

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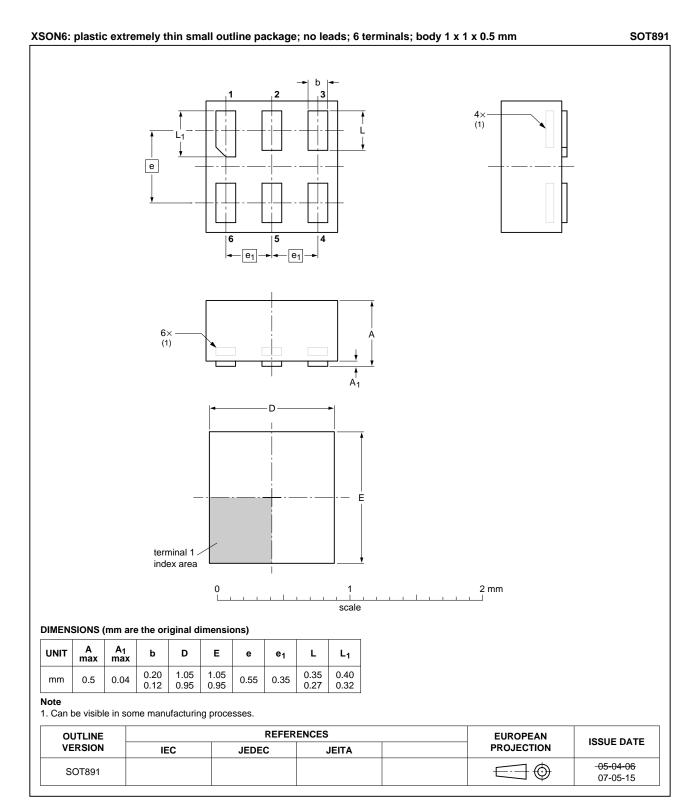


Fig 13. Package outline SOT891 (XSON6)

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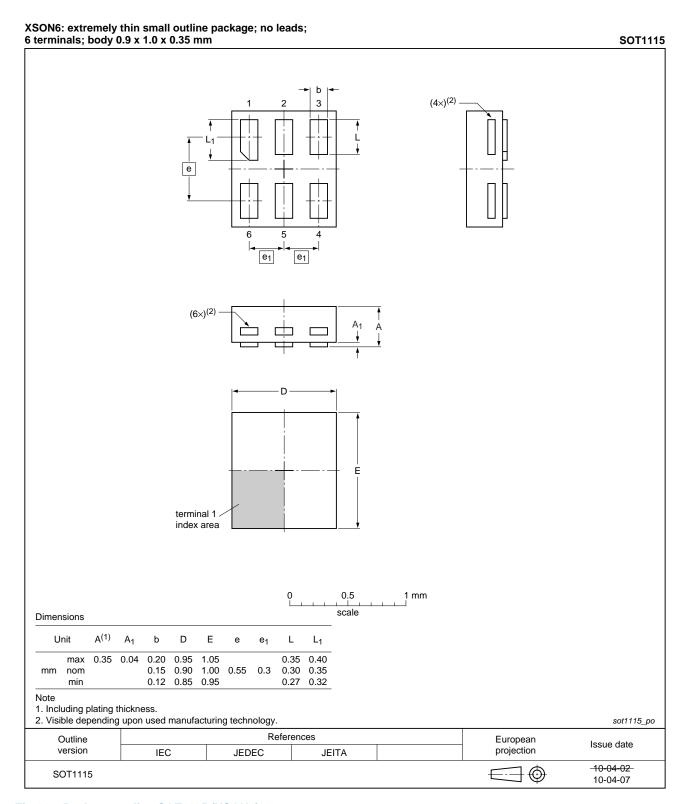


Fig 14. Package outline SOT1115 (XSON6)

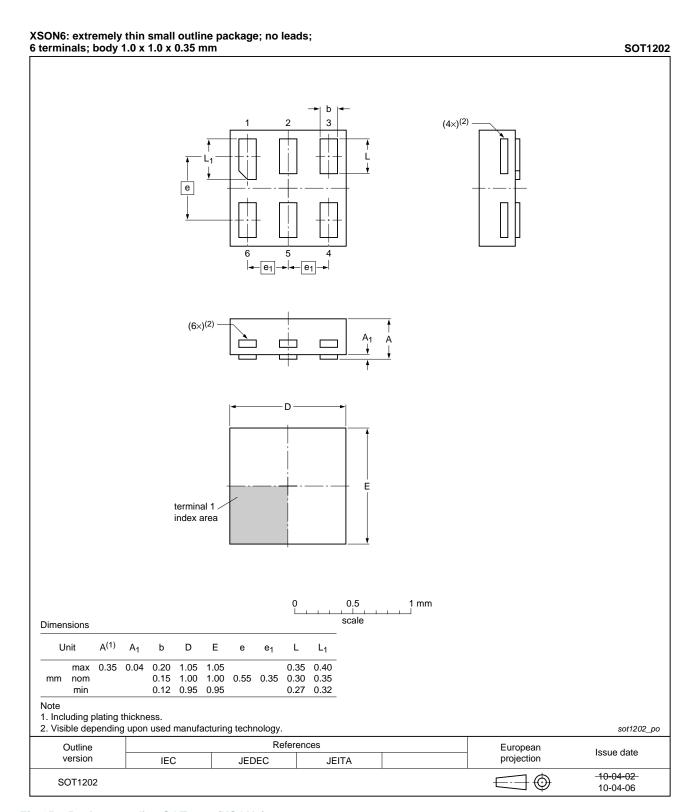


Fig 15. Package outline SOT1202 (XSON6)

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## 14. Abbreviations

#### Table 11. Abbreviations

Acronym	Description
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

# 15. Revision history

#### Table 12. Revision history

	•			
Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC1G157 v.6	20121231	Product data sheet	-	74LVC1G157 v.5
Modifications:	<ul> <li>Package ou</li> </ul>	tline drawing of SOT886 (	Figure 12) modified.	
74LVC1G157 v.5	20111206	Product data sheet	-	74LVC1G157 v.4
Modifications:	<ul> <li>Legal pages</li> </ul>	s updated.		
74LVC1G157 v.4	20101028	Product data sheet	-	74LVC1G157 v.3
74LVC1G157 v.3	20070712	Product data sheet	-	74LVC1G157 v.2
74LVC1G157 v.2	20061011	Product data sheet	-	74LVC1G157 v.1
74LVC1G157 v.1	20050425	Product data sheet	-	-

### 16. Legal information

#### 16.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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#### Single 2-input multiplexer

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### 18. Contents

1	General description
2	Features and benefits
3	Ordering information 2
4	Marking 2
5	Functional diagram 2
6	Pinning information
6.1	Pinning
6.2	Pin description 4
7	Functional description 4
8	Limiting values 4
9	Recommended operating conditions 5
10	Static characteristics 5
11	Dynamic characteristics 6
12	Waveforms
13	Package outline 9
14	Abbreviations
15	Revision history
16	Legal information
16.1	Data sheet status
16.2	Definitions
16.3	Disclaimers
16.4	Trademarks 17
17	Contact information
18	Contents

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